



DECLARATION FOR UNITED STATES PATENT APPLICATION

As a below named inventor, I (we) hereby declare that:

My residence, post office address and citizenship are the same as stated below next to my name.

I (we) believe I am (we are) an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

SHOE ASSEMBLY, SHOE AND RELATED FOOTWEAR METHOD

the specification of which (check one)

☐ is attached hereto.

☒ was filed on July 22, 2003 as Application Serial No. 10/625,075

and was amended on _____ (if applicable).

☐ was filed as PCT International application No. _____ on _____

and was amended on _____ (if applicable).

I (we) hereby state that I (we) have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I (we) acknowledge the duty to disclose information known to me to be material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I (we) hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Number

Country

Filing Date

Priority Claimed

☐

Yes

☐

No

I (we) hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below:

Number	Filing Date (mm/dd/yyyy)
_____	_____

I (we) hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulation, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

Application Serial No.	Filing Date	Status (Patented, Pending, Abandoned)
_____	_____	_____

I (we) hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Henry D. Coleman, Reg. No. 32,559;
R. Neil Sudol, Reg. No. 31,669;
William J. Sapone, Reg. No. 32,519

of

Coleman Sudol Sapone, P.C.
714 Colorado Avenue
Bridgeport, Connecticut 06605-1601.

Direct all telephone calls to:	R. Neil Sudol	at Telephone No. (203) 366-3560
--------------------------------	---------------	---------------------------------

Address all correspondence to:	R. Neil Sudol	At
--------------------------------	---------------	----

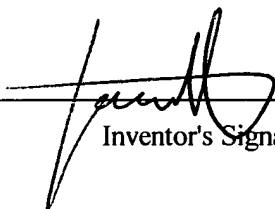
Coleman Sudol Sapone, P.C.
714 Colorado Avenue
Bridgeport, Connecticut 06605-1601

I (we) hereby declare that all statements made herein of my (our) own knowledge are true, and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor:	Jacob Safdeye
Residence:	1378 Ocean Parkway, Brooklyn, NY, 11230
Post Office Address:.	Same as above
Country of Citizenship:. . . .	United States of America

8/11/05

Date



Inventor's Signature